

# Single P-channel MOSFET

## ELM16401EA-S

### ■General description

ELM16401EA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and operation with gate voltages as low as 2.5V.

### ■Features

- $V_{ds} = -30V$
- $I_d = -5A$  ( $V_{gs} = -10V$ )
- $R_{ds(on)} < 49m\Omega$  ( $V_{gs} = -10V$ )
- $R_{ds(on)} < 64m\Omega$  ( $V_{gs} = -4.5V$ )
- $R_{ds(on)} < 119m\Omega$  ( $V_{gs} = -2.5V$ )

### ■Maximum absolute ratings

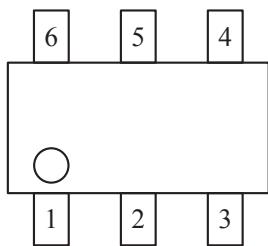
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	-30	V	
Gate-source voltage	$V_{gs}$	$\pm 12$	V	
Continuous drain current	$I_d$	-5.0	A	1
		-4.2		
Pulsed drain current	$I_{dm}$	-30	A	2
Power dissipation	$P_d$	2.00	W	1
		1.44		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	47.5	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	37.0	50.0	°C/W	3

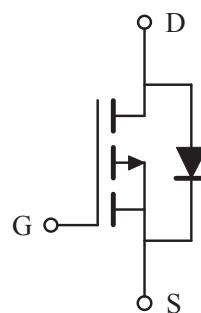
### ■Pin configuration

SOT-26(TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

### ■Circuit



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### ■Electrical characteristics

T<sub>a</sub>=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
<b>STATIC PARAMETERS</b>								
Drain-source breakdown voltage	BVdss	Id=-250μA, V <sub>gs</sub> =0V		-30			V	
Zero gate voltage drain current	Idss	V <sub>ds</sub> =-24V, V <sub>gs</sub> =0V	T <sub>j</sub> =55°C			-1		
						-5	μA	
Gate-body leakage current	I <sub>gss</sub>	V <sub>ds</sub> =0V, V <sub>gs</sub> =±12V				±100	nA	
Gate threshold voltage	V <sub>gs(th)</sub>	V <sub>ds</sub> =V <sub>gs</sub> , Id=-250μA		-0.7	-1.0	-1.3	V	
On state drain current	Id(on)	V <sub>gs</sub> =-4.5V, V <sub>ds</sub> =-5V		-25			A	
Static drain-source on-resistance	R <sub>ds(on)</sub>	V <sub>gs</sub> =-10V, Id=-5A			42	49		
				T <sub>j</sub> =125°C		74	mΩ	
		V <sub>gs</sub> =-4.5V, Id=-4A			53	64	mΩ	
		V <sub>gs</sub> =-2.5V, Id=-1A			81	119	mΩ	
Forward transconductance	G <sub>fs</sub>	V <sub>ds</sub> =-5V, Id=-5A		7	11		S	
Diode forward voltage	V <sub>sd</sub>	I <sub>s</sub> =-1A, V <sub>gs</sub> =0V			-0.75	-1.00	V	
Max. body-diode continuous current	I <sub>s</sub>					-3	A	
<b>DYNAMIC PARAMETERS</b>								
Input capacitance	C <sub>iss</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =-15V, f=1MHz			943		pF	
Output capacitance	C <sub>oss</sub>				108		pF	
Reverse transfer capacitance	C <sub>rss</sub>				73		pF	
Gate resistance	R <sub>g</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =0V, f=1MHz			6		Ω	
<b>SWITCHING PARAMETERS</b>								
Total gate charge	Q <sub>g</sub>	V <sub>gs</sub> =-4.5V, V <sub>ds</sub> =-15V Id=-5A			9.5		nC	
Gate-source charge	Q <sub>gs</sub>				2.1		nC	
Gate-drain charge	Q <sub>gd</sub>				2.9		nC	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>gs</sub> =-10V, V <sub>ds</sub> =-15V R <sub>l</sub> =3Ω, R <sub>gen</sub> =6Ω			6		ns	
Turn-on rise time	t <sub>r</sub>				3		ns	
Turn-off delay time	t <sub>d(off)</sub>				40		ns	
Turn-off fall time	t <sub>f</sub>				11		ns	
Body diode reverse recovery time	t <sub>rr</sub>				21.2		ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>f</sub> =-5A, dI/dt=100A/μs			12.8		nC	

### NOTE :

1. The value of R<sub>θja</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with T<sub>a</sub>=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R<sub>θja</sub> is the sum of the thermal impedance from junction to lead R<sub>θjl</sub> and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>a</sub>=25°C. The SOA curve provides a single pulse rating.



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### ■ Typical electrical and thermal characteristics

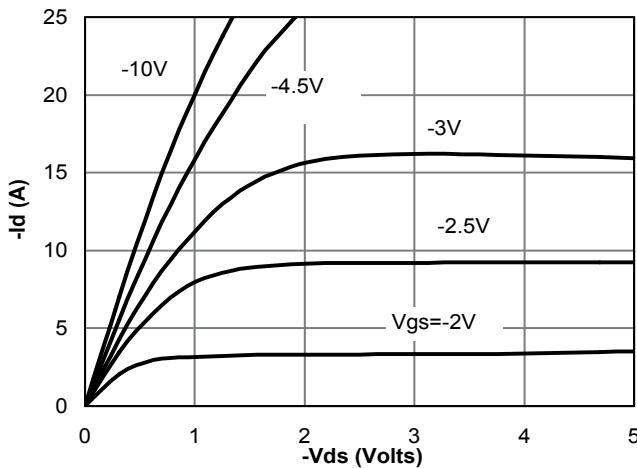


Fig 1: On-Region Characteristics

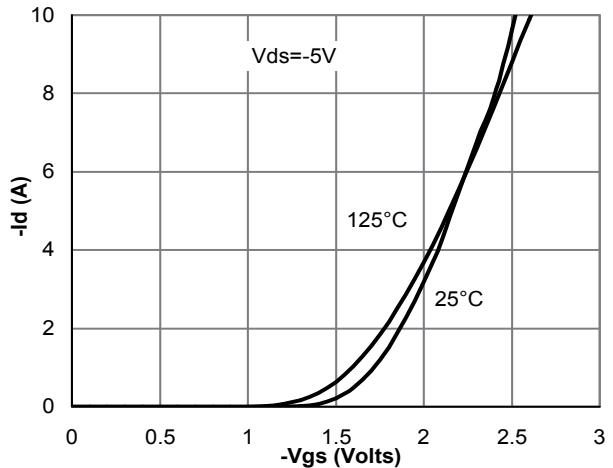


Figure 2: Transfer Characteristics

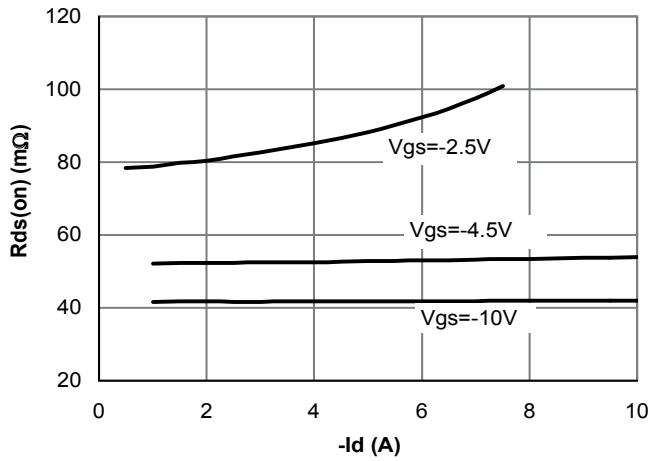


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

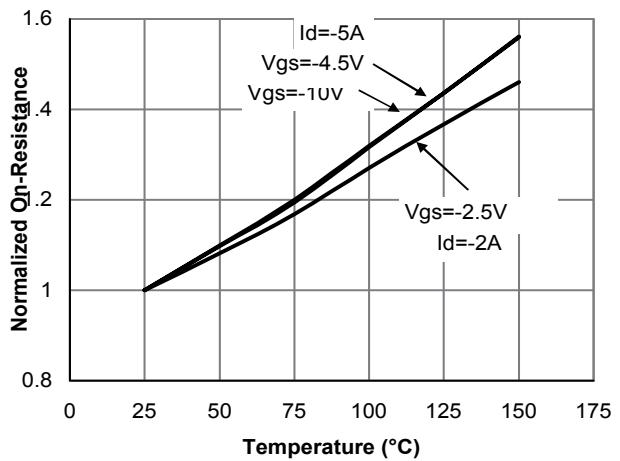


Figure 4: On-Resistance vs. Junction Temperature

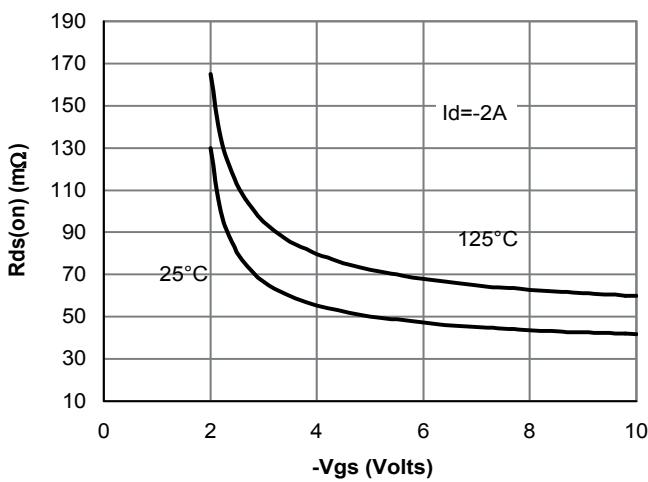


Figure 5: On-Resistance vs. Gate-Source Voltage

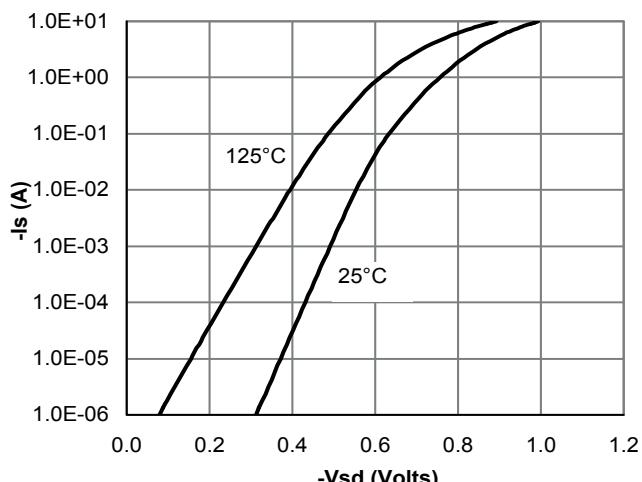


Figure 6: Body-Diode Characteristics

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